

TECHNICAL DATA SHEET 2 / 7				
SMT I	BOARD TO BOAH	Н3	R107.064.910	
REEL OF 600				Series : IMP
PACKAGINGStandardUnitOther600R107.064.920WContact us		SPECIFICATION		
ELECTRICAL CHARACTERISTICS			ENVIRONMENTAL	
Impedance Frequency VSWR Insertion loss RF leakage Voltage rating	1.10 + 0,0300 0.2 - (GHz	Operating temper Hermetic seal Panel leakage	rature -40/+90 ° C Atm.cm3/s
Dielectric withstanding voltage350Veff miniInsulation resistance3000MΩ mini			OTHER CHARACTERISTICS	
			Assembly instruc Others : Weight reel : 256 g	
MECHANICAL CHARACTE		N mini N mini N.cm mini		
Recommended torque Mating Panel nut	e	N.cm N.cm		
Mating life Weight	20 0,0200	Cycles mini g		
Issue : 0721 B In the effort to improve our products, we reserve the right to make changes judged to be necessary.				

TECHNICAL DATA SHEET

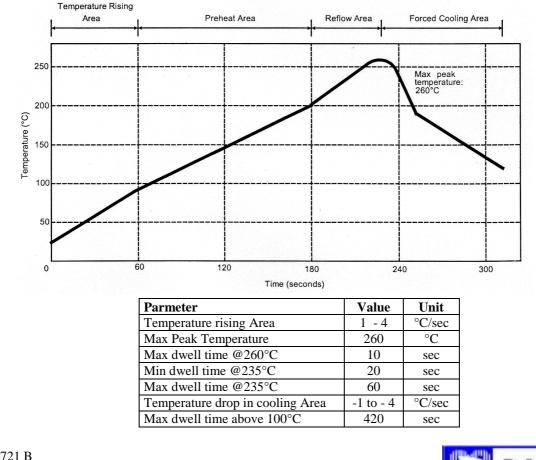
SMT BOARD TO BOARD ADAPTOR H3

REEL OF 600

R107.064.910 Series : **IMP**

SOLDER PROCEDURE

- Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component . Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven . Below please find , the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.
- NOTE : The receptacle and the plug must not be mated before completion of this procedure



TEMPERATURE PROFILE

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